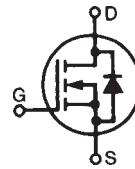


Polar™ Power MOSFET
HiPerFET™

N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Diode

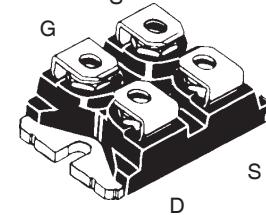
IXFN52N90P

V_{DSS}	= 900V
I_{D25}	= 43A
$R_{DS(on)}$	$\leq 160\text{m}\Omega$
t_{rr}	$\leq 300\text{ns}$

miniBLOC, SOT-227



E153432



G = Gate D = Drain
S = Source

Either Source terminal S can be used as the Source terminal or the Kelvin Source (gate return) terminal.

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	$T_J = 25^\circ\text{C}$ to 150°C	900	V	
V_{DGR}	$T_J = 25^\circ\text{C}$ to 150°C , $R_{GS} = 1\text{M}\Omega$	900	V	
V_{GSS}	Continuous	± 30	V	
V_{GSM}	Transient	± 40	V	
I_{D25}	$T_C = 25^\circ\text{C}$	43	A	
I_{DM}	$T_C = 25^\circ\text{C}$, pulse width limited by T_{JM}	104	A	
I_A	$T_C = 25^\circ\text{C}$	26	A	
E_{AS}	$T_C = 25^\circ\text{C}$	2	J	
dV/dt	$I_S \leq I_{DM}$, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ\text{C}$	20	V/ns	
P_D	$T_C = 25^\circ\text{C}$	890	W	
T_J		-55 ... +150	$^\circ\text{C}$	
T_{JM}		150	$^\circ\text{C}$	
T_{stg}		-55 ... +150	$^\circ\text{C}$	
T_L	1.6mm (0.062 in.) from case for 10s	300	$^\circ\text{C}$	
V_{ISOL}	50/60 Hz, RMS $I_{ISOL} \leq 1\text{mA}$	t = 1min t = 1s	2500 3000	V~ V~
M_d	Mounting torque Terminal connection torque	1.5/13 1.3/11.5	Nm/lb.in. Nm/lb.in.	
Weight		30	g	

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
BV_{DSS}	$V_{GS} = 0\text{V}$, $I_D = 3\text{mA}$	900		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 1\text{mA}$	3.5		6.5 V
I_{GSS}	$V_{GS} = \pm 30\text{V}$, $V_{DS} = 0\text{V}$			± 200 nA
I_{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0\text{V}$			50 μA 4 mA
$R_{DS(on)}$	$V_{GS} = 10\text{V}$, $I_D = 26\text{A}$, Note 1			160 m Ω

Features

- International standard package
- miniBLOC, with Aluminium nitride isolation
- Avalanche Rated
- Low package inductance
- Fast intrinsic diode

Advantages

- Low gate drive requirement
- High power density

Applications:

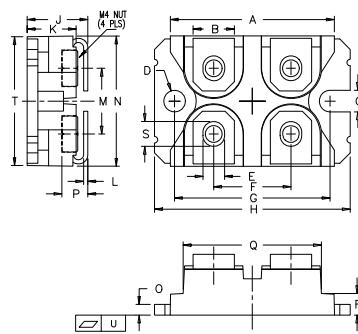
- Switched-mode and resonant-mode power supplies
- DC-DC Converters
- Laser Drivers
- AC and DC motor drives
- Robotics and servo controls

Symbol	Test Conditions (T _J = 25°C unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
g_{fs}	V _{DS} = 20V, I _D = 26A, Note 1	20	35	S
R _{Gi}	Gate input resistance	1.56		Ω
C _{iss}	{ V _{GS} = 0V, V _{DS} = 25V, f = 1MHz }	19		nF
C _{oss}		1180		pF
C _{rss}		24		pF
t _{d(on)}	{ Resistive Switching Times V _{GS} = 10V, V _{DS} = 0.5 • V _{DSS} , I _D = 26A R _G = 1Ω (External) }	63		ns
t _r		80		ns
t _{d(off)}		95		ns
t _f		42		ns
Q _{g(on)}	{ V _{GS} = 10V, V _{DS} = 0.5 • V _{DSS} , I _D = 26A }	308		nC
Q _{gs}		117		nC
Q _{gd}		132		nC
R _{thJC}			0.14	°C/W
R _{thCS}		0.05		°C/W

Source-Drain DiodeT_J = 25°C unless otherwise specified)

		Characteristic Values		
		Min.	Typ.	Max.
I _s	V _{GS} = 0V		56	A
I _{SM}	Repetitive, pulse width limited by T _{JM}		208	A
V _{SD}	I _F = I _S , V _{GS} = 0V, Note 1		1.5	V
t _r	{ I _F = 26A, -di/dt = 100A/μs V _R = 100V }		300	ns
Q _{RM}		1.8		μC
I _{RM}		26		A

Note 1: Pulse test, t ≤ 300μs; duty cycle, d ≤ 2%.

SOT-227B Outline

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.240	1.255	31.50	31.88
B	.307	.323	7.80	8.20
C	.161	.169	4.09	4.29
D	.161	.169	4.09	4.29
E	.161	.169	4.09	4.29
F	.587	.595	14.91	15.11
G	1.186	1.193	30.12	30.30
H	1.496	1.505	38.00	38.23
J	.460	.481	11.68	12.22
K	.351	.378	8.92	9.60
L	.030	.033	0.76	0.84
M	.496	.506	12.60	12.85
N	.990	1.001	25.15	25.42
O	.078	.084	1.98	2.13
P	.195	.235	4.95	5.97
Q	1.045	1.059	26.54	26.90
R	.155	.174	3.94	4.42
S	.186	.191	4.72	4.85
T	.968	.987	24.59	25.07
U	-.002	.004	-0.05	0.1

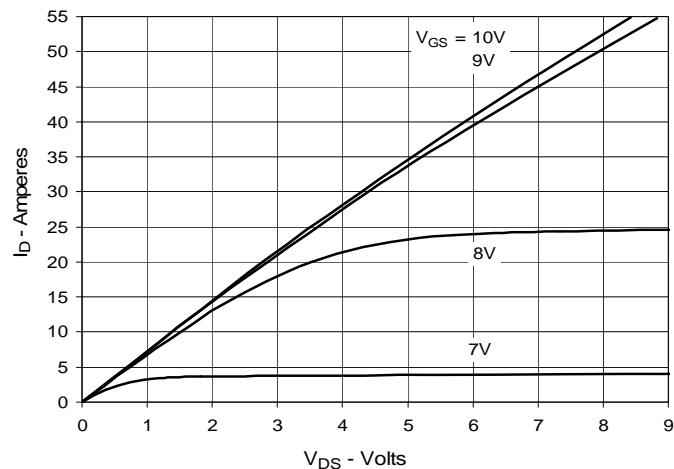
PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

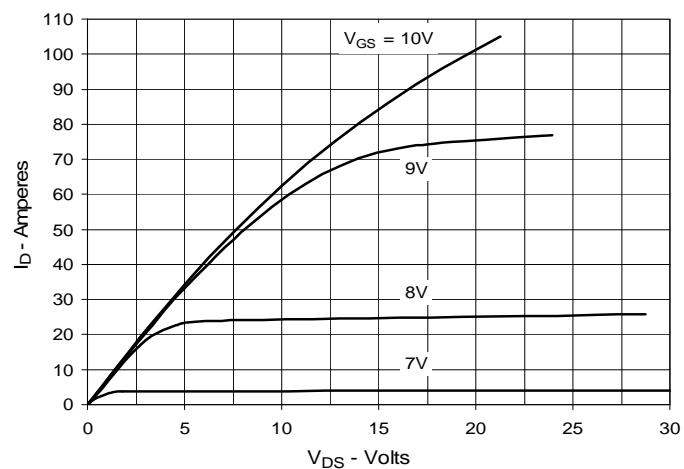
IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

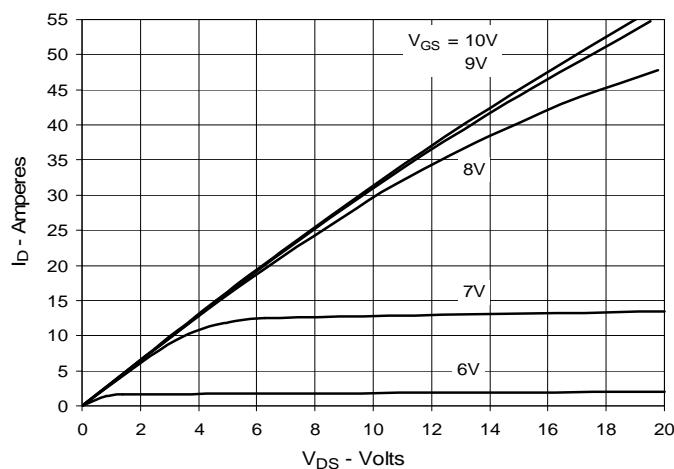
**Fig. 1. Output Characteristics
@ 25°C**



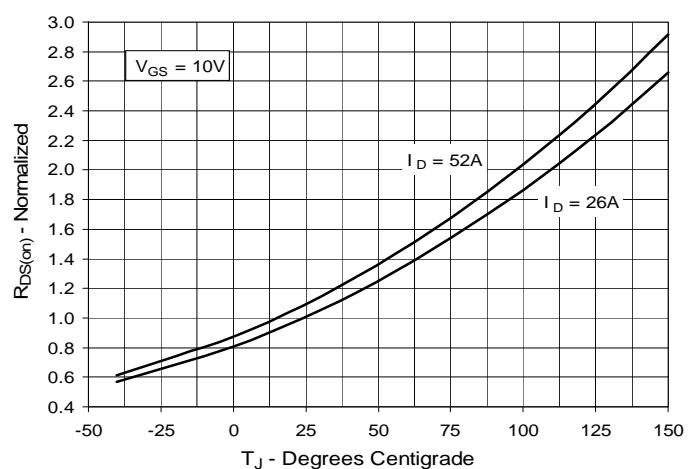
**Fig. 2. Extended Output Characteristics
@ 25°C**



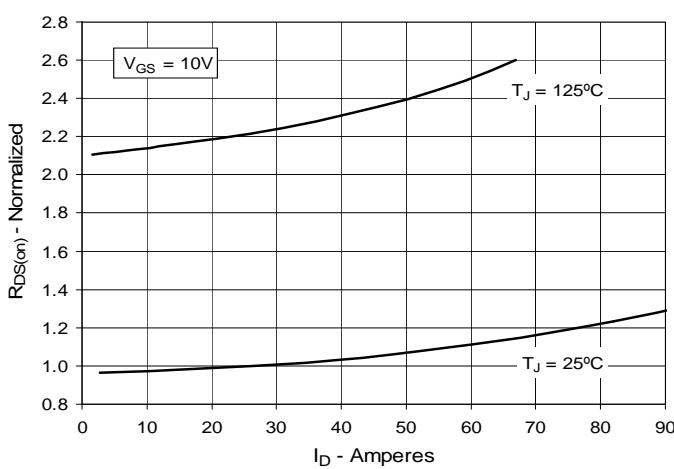
**Fig. 3. Output Characteristics
@ 125°C**



**Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 26A$ Value
vs. Junction Temperature**



**Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 26A$ Value
vs. Drain Current**



**Fig. 6. Maximum Drain Current vs.
Case Temperature**

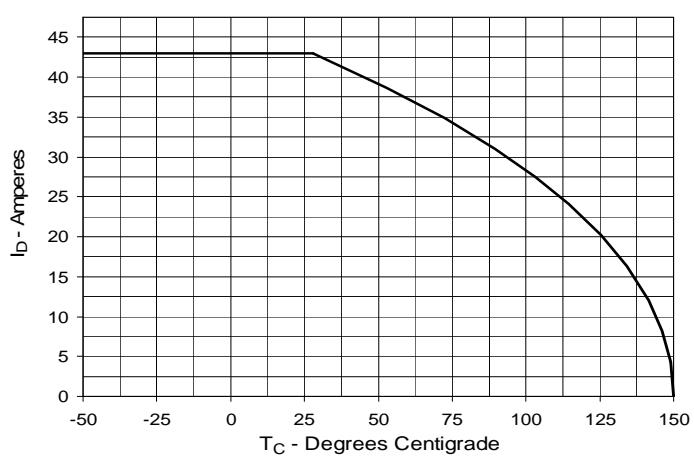
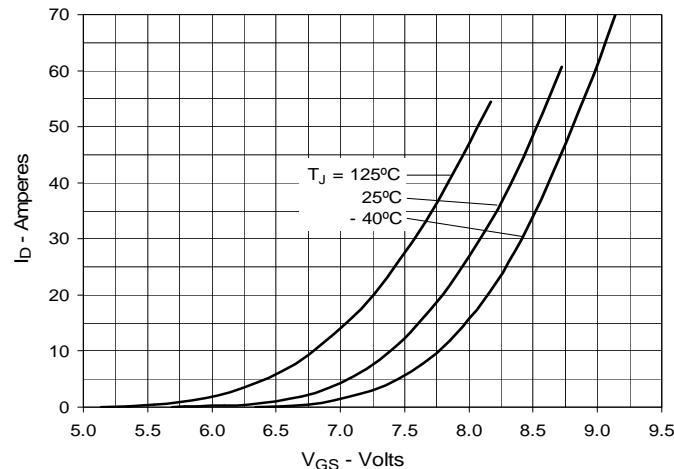
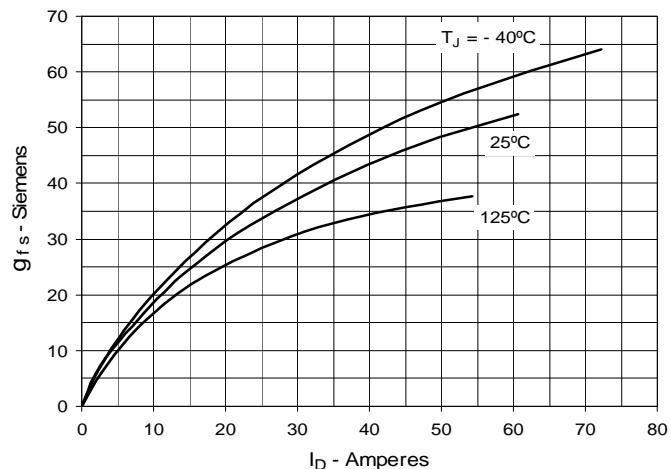
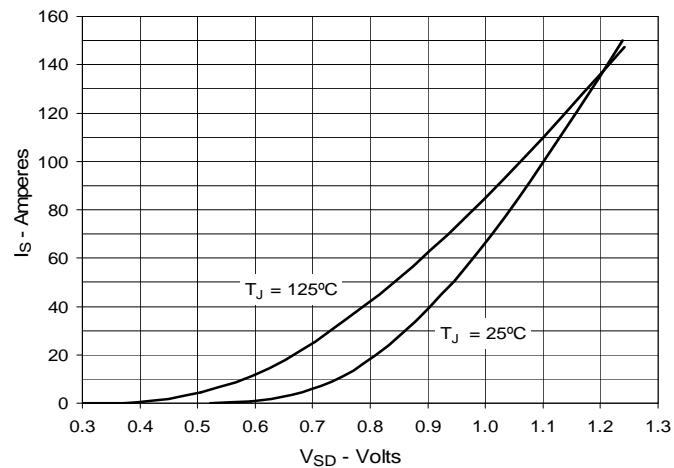
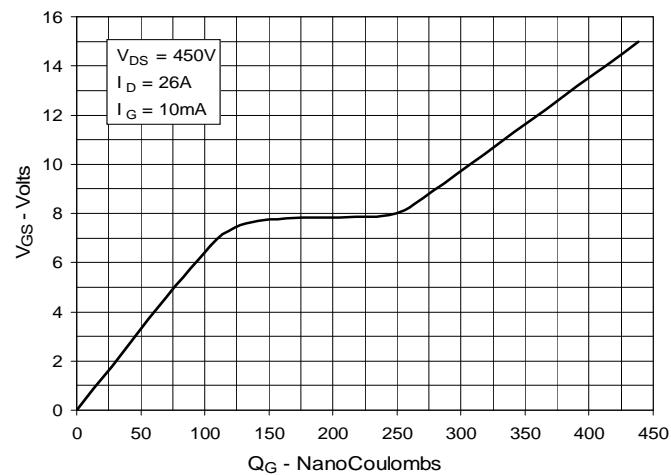
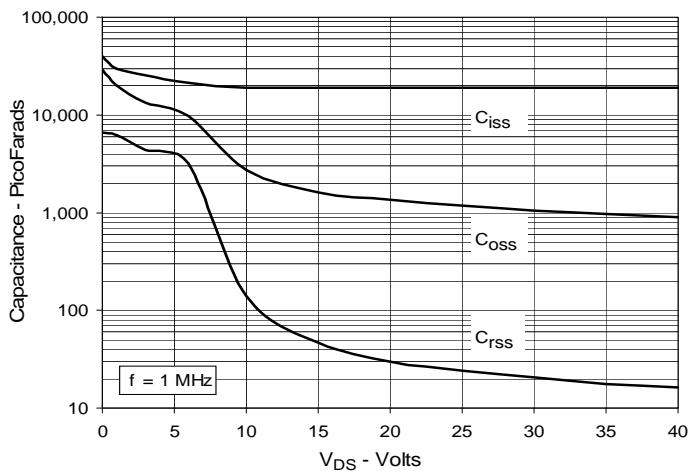
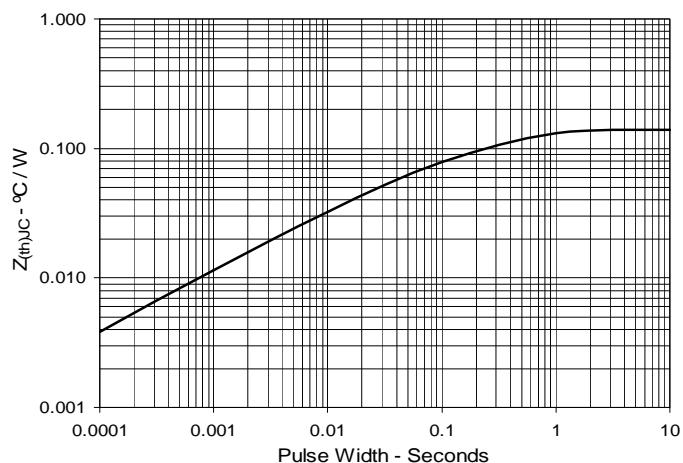


Fig. 7. Input Admittance**Fig. 8. Transconductance****Fig. 9. Forward Voltage Drop of Intrinsic Diode****Fig. 10. Gate Charge****Fig. 11. Capacitance****Fig. 12. Maximum Transient Thermal Impedance**

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